

Features

- Split Gate Trench MOSFET Technology
- Excellent Package for Heat Dissipation
- Moisture Sensitivity Level 1
- Halogen Free."Green" Device^(Note1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant^(Note2)("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

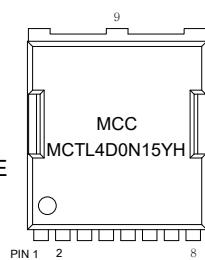
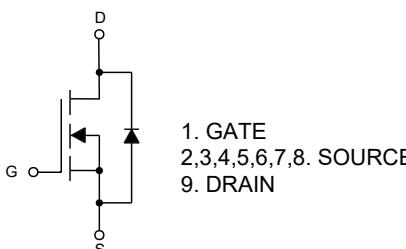
- Operating Junction Temperature Range : -55°C to +175°C
- Storage Temperature Range: -55°C to +175°C
- Thermal Resistance: 40°C/W Junction to Ambient^(Note3)
- Thermal Resistance: 0.39°C/W Junction to Case

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	150	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	T _C =25°C	I _D	A
	T _C =100°C	190	
Pulsed Drain Current ^(Note4)	I _{DM}	760	A
Total Power Dissipation ^(Note5)	P _D	384	W
Single Pulsed Avalanche Energy ^(Note6)	E _{AS}	900	mJ

Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. High Temperature Solder Exemption Applied, see EU Directive Annex 7a.
3. The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C.
4. Repetitive rating; pulse width limited by max. junction temperature.
5. P_D is based on max. junction temperature, using junction-case thermal resistance.
6. T_J=25°C, V_{DD}=100V, V_{GS}=10V, R_G=25Ω, L=0.5mH.

Internal Structure and Marking Code



N-CHANNEL MOSFET

TOLL-8L				
DIMENSIONS				
DIM	INCHES		MM	
	MIN	MAX	MIN	MAX
A	0.087	0.094	2.20	2.40
B	0.028	0.035	0.70	0.90
C	0.382	0.390	9.70	9.90
D	0.017	0.020	0.42	0.50
E	0.016	0.024	0.40	0.60
F	0.405	0.417	10.28	10.58
G	0.122	0.138	3.10	3.50
H	0.382	0.398	9.70	10.10
I	0.311	0.327	7.90	8.30
J	0.047		1.20	
K	0.452	0.468	11.48	11.88
L	0.266	0.281	6.75	7.15
M	0.315		8.00	
N	0.118	0.130	3.00	3.30
O	0.157	0.172	3.98	4.38
P	0.055	0.071	1.40	1.80
Q	0.024	0.031	0.60	0.80
R	0.020	0.028	0.50	0.70
S	0.039	0.051	1.00	1.30
θ	4°	10°	4°	10°

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	150			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS} = \pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=150V, V_{GS}=0V$			1	uA
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5	3.2	4.5	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=50A$		3.1	4.0	$m\Omega$
Gate Resistance	R_g	f=1MHz, Open Drain		2.2		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				190	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=50A$			1.2	V
Reverse Recovery Time	t_{rr}	$I_F=50A, dI_F/dt=100A/\mu s$		113		ns
Reverse Recovery Charge	Q_{rr}			318		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=75V, V_{GS}=0V, f=1MHz$		7046		pF
Output Capacitance	C_{oss}			775		
Reverse Transfer Capacitance	C_{rss}			21		
Total Gate Charge	Q_g	$V_{DS}=75V, V_{GS}=10V, I_D=50A$		92.5		nC
Gate-Source Charge	Q_{gs}			30		
Gate-Drain Charge	Q_{gd}			24		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=75V, V_{GS}=10V, R_G=3\Omega, I_{DS}=50A$		28		ns
Turn-On Rise Time	t_r			88		
Turn-Off Delay Time	$t_{d(off)}$			57		
Turn-Off Fall Time	t_f			48		

Curve Characteristics

Fig.1 - Typical Output Characteristics

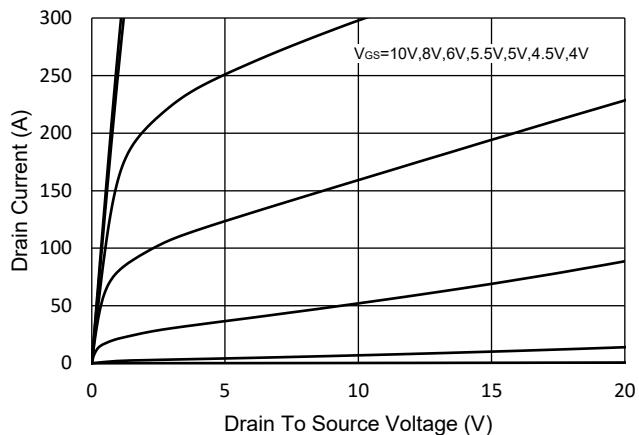


Fig.2 - Transfer Characteristic

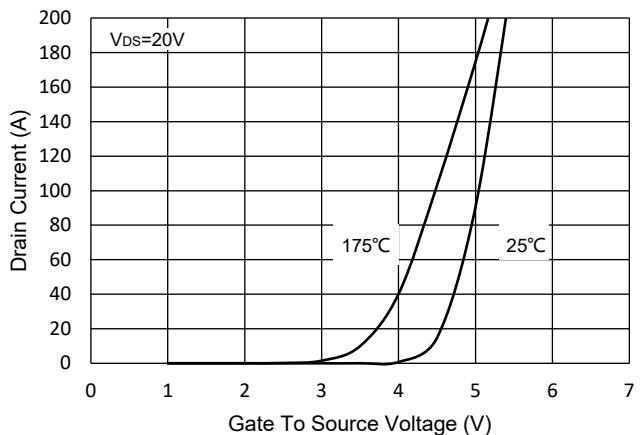


Fig.3 - $R_{DS(ON)}$ - V_{GS}

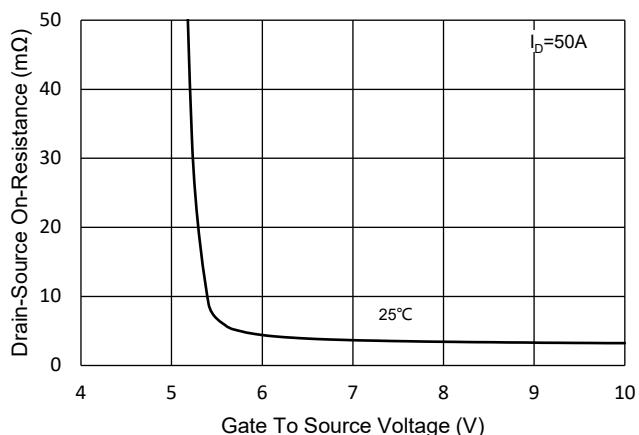


Fig.4 - $R_{DS(ON)}$ - I_D

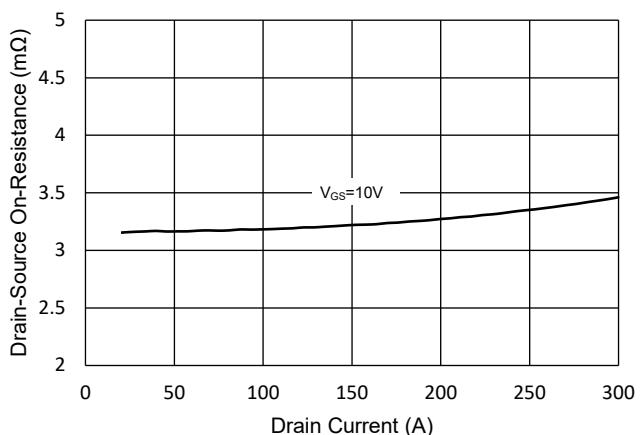


Fig.5 - Capacitance Characteristics

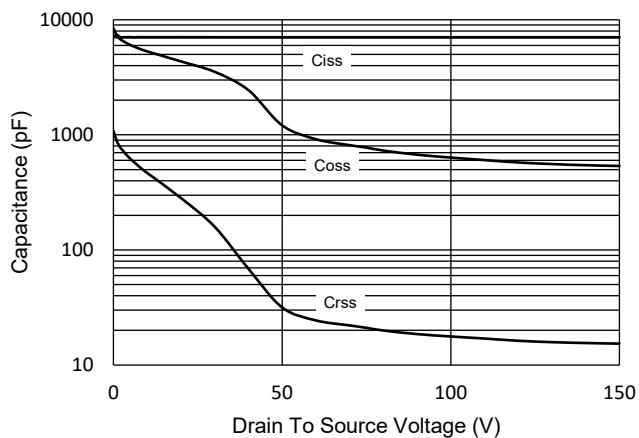
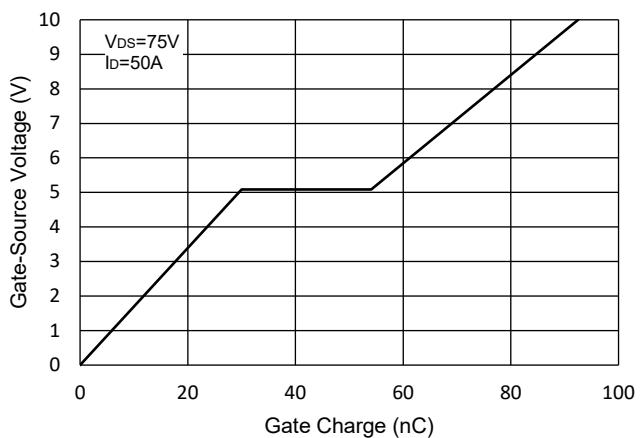
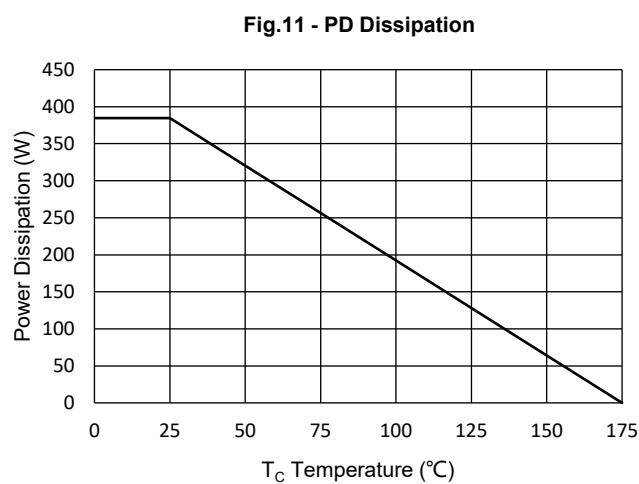
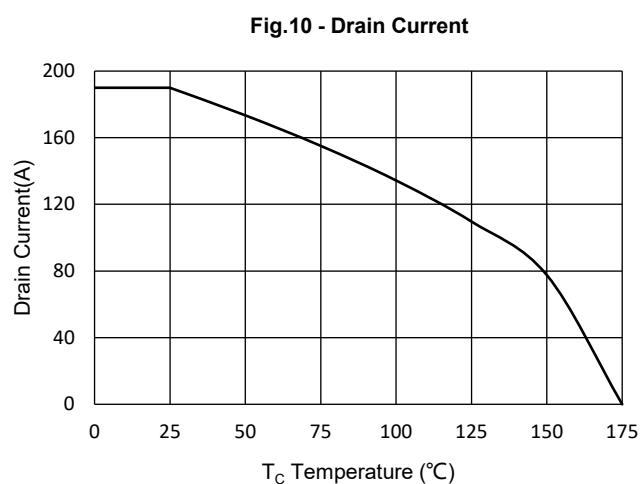
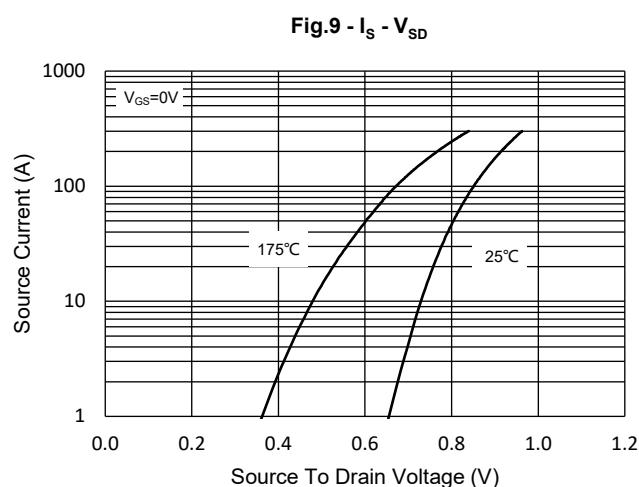
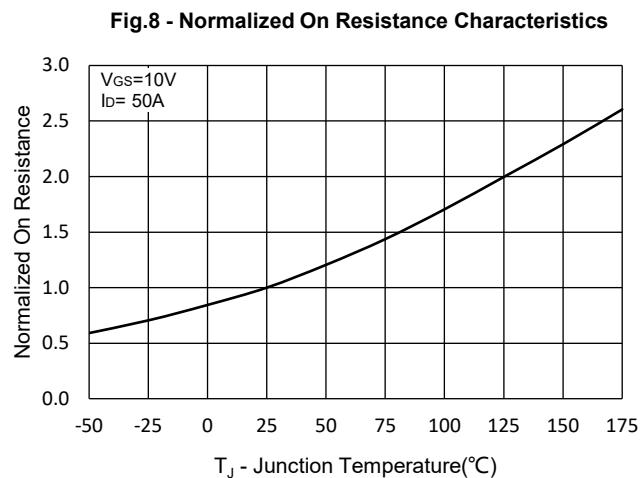
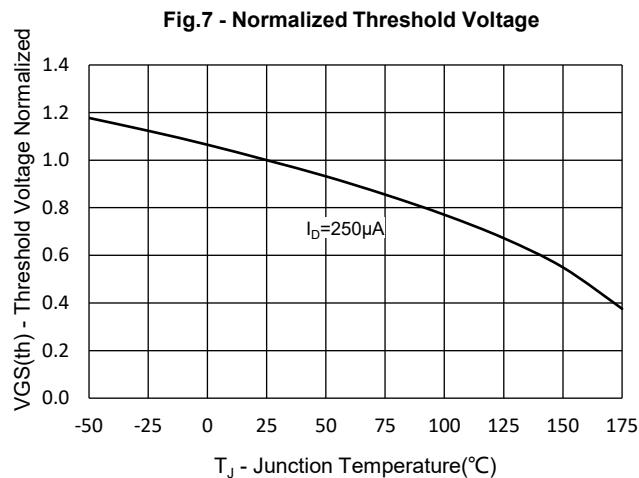


Fig.6 - Gate Charge



Curve Characteristics



Curve Characteristics

Fig.12 - Safe Operation Area

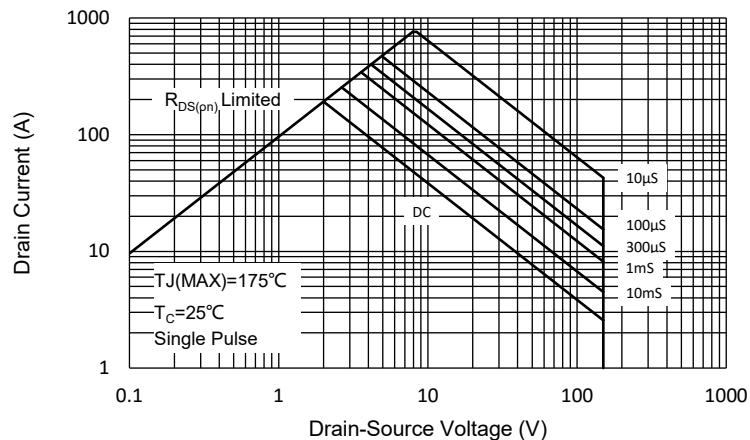
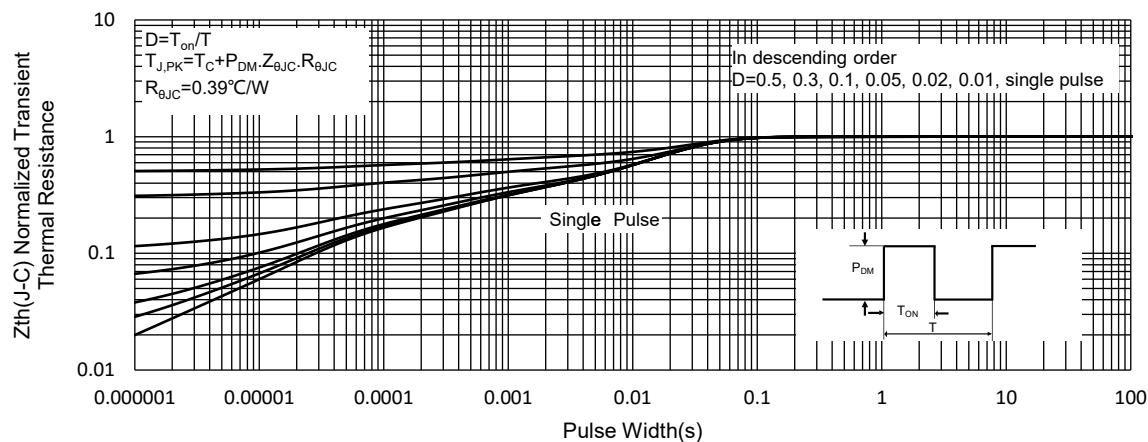


Fig.13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 2Kpcs/Reel

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